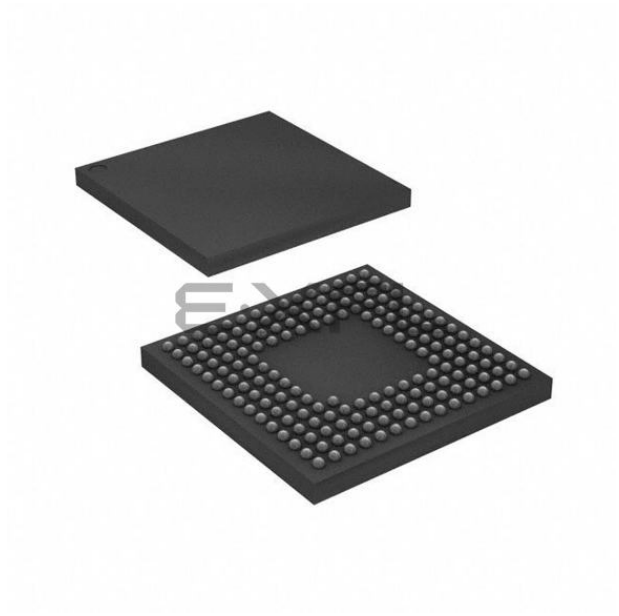


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

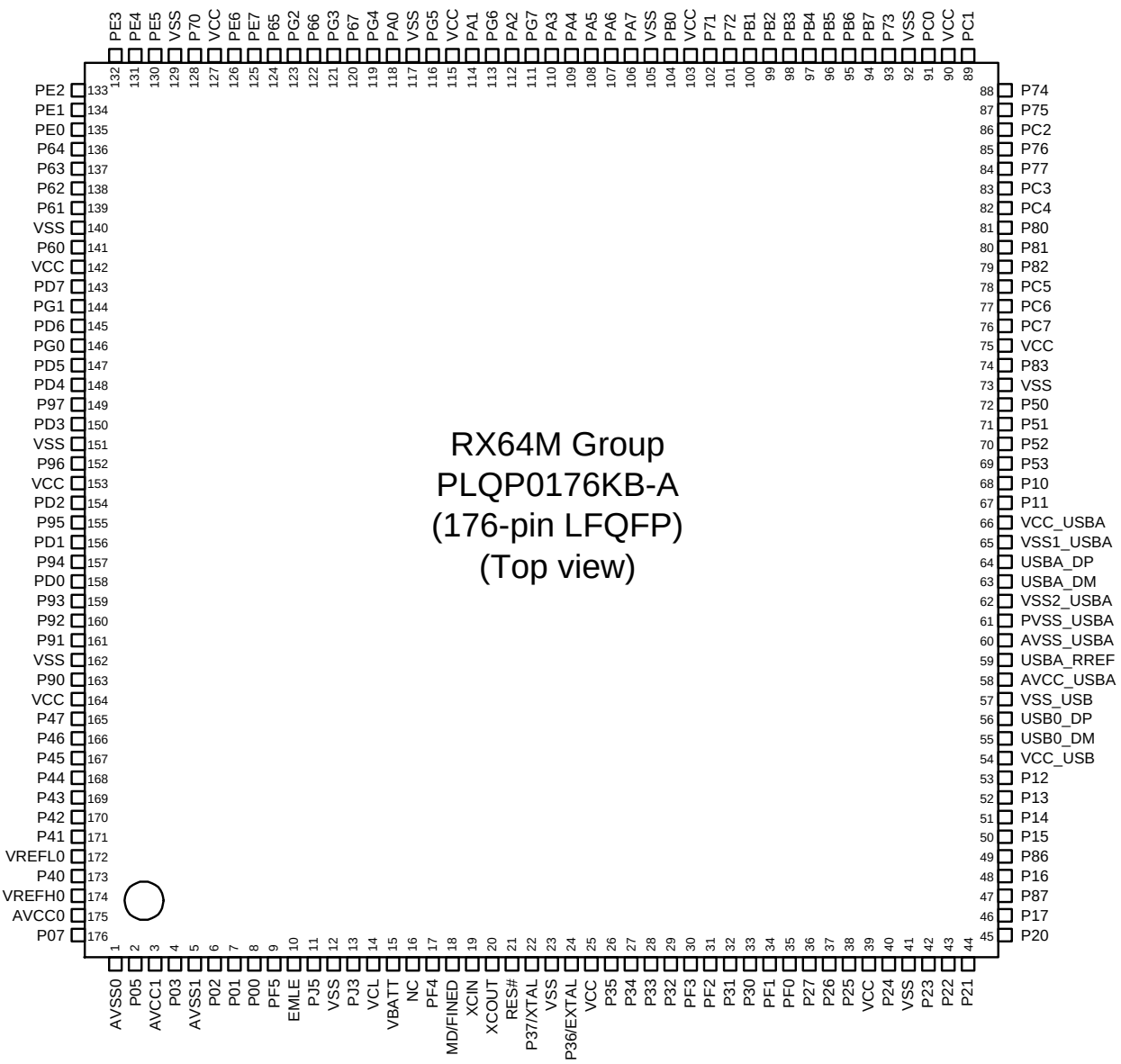
Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	127
Program Memory Size	3MB (3M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 29x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	177-TFLGA
Supplier Device Package	177-TFLGA (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mjgdlc-21

Table 1.1 Outline of Specifications (7/9)

Classification	Module/Function	Description
Communication function	I²C bus interface (RIICa)	• 2 channels (only channel 0 can be used in fast-mode plus) Communication formats I²C bus format/SMBus format Supports the multi-master Max. transfer rate: 1 Mbps (channel 0) • Event linking by the ELC
	CAN module (CAN)	• 3 channels • Compliance with the ISO11898-1 specification (standard frame and extended frame) • 32 mailboxes per channel
	Serial peripheral interface (RSPIa)	• 1 channel • RSPI transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave • Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Buffered structure Double buffers for both transmission and reception • RSPCK can be stopped with the receive buffer full for master reception. • Event linking by the ELC
	Quad serial peripheral interface (QSPI)	• 1 channel • Connectable with serial flash memory equipped with multiple input and output lines (i.e. for single, dual, or quad operation) • Programmable bit length and selectable active sense and phase of the clock signal • Sequential execution of transfer • LSB or MSB first is selectable.
Serial sound interface (SSI)		• 2 channels • Full-duplex transfer is possible (only on channel 0). • Support for multiple audio formats • Support for master or slave operation • Bit clock frequency is selectable from four different types (16 fs, 32 fs, 48 fs, and 64 fs). • Support for 8-/16-/18-/20-/22-/24 bit data formats • Internal 8-stage FIFO for transmission and reception • Stopping SSIWS when data transfer is stopped is selectable.
Sampling rate converter (SRC)		• 1 channel • Data formats: 32-bit stereo (16 bits for the left, 16 bits for the right) and 16-bit monaural. • Input sampling rates: 8, 11.025, 12, 16, 22.05, 24, 32, 44.1, 48 kHz • Output sampling rates: 32, 44.1, 48, 8*2 or 16 kHz*2
SD host interface (SDHI)*4		• 1 channel • Transfer speed: Supports high-speed mode (15 MB/s) and default speed mode (10 MB/s) • One interface for SD memory and I/O cards (supporting 1- and 4-bit SD buses) • SD specifications Part 1: Physical Layer Specification Ver. 3.01 compliant (DDR not supported) Part E1: SDIO Specification Ver. 3.00 • Error checking: CRC7 for commands and CRC16 for data • Interrupt requests: Card access interrupt, SDIO access interrupt, card detection interrupt • DMA transfer requests: SD_BUF write and SD_BUF read • Support for card detection and write protection
MMC host interface (MMCIF)		• 1 channel • Transfer speed: Supports high-speed mode (30 MB/s) and Backward-compatible mode (25 MB/s) • Compliant with JEDEC STANDARD JESD84-A441 (DDR is not supported) • Interface for Multimedia Cards (MMCs) • Device buses: Support for 1-, 4-, and 8-bit MMC buses • Interrupt requests: Card detection interrupt, error/timeout interrupt, normal operation interrupt • DMA transfer requests: CE_DATA write and CE_DATA read • Support for card detection, boot operation, high priority interrupt (HPI)

Table 1.4 Pin Functions (6/8)

Classifications	Pin Name	I/O	Description
USB 2.0 host/function module	VCC_USB, VCC_USBA	Input	Power supply pins
	VSS_USB, VSS1_USBA, VSS2_USBA	Input	Ground pins
	AVCC_USBA	Input	USBA analog power supply pin
	AVSS_USBA	Input	USBA analog ground pin. Short this pin with the PVSS_USBA pin.
	PVSS_USBA	Input	USBA PLL circuit ground pin. Short this pin with the AVSS_USBA pin.
	USBA_RREF	I/O	USBA reference current supply pin. Connect 2.2 kΩ (±1%) to the AVSS_USBA pin.
	USB0_DP, USBA_DP	I/O	Input or output USB transceiver D+ data.
	USB0_DM, USBA_DM	I/O	Input or output USB transceiver D- data.
	USB0_EXICEN, USBA_EXICEN	Output	Connect to the OTG power IC.
	USB0_ID, USBA_ID	Input	Connect to the OTG power IC.
	USB0_VBUSEN USBA_VBUSEN	Output	USB VBUS power enable pins
	USB0_OVRCURA/ USB0_OVRCURB, USBA_OVRCURA/ USBA_OVRCURB	Input	USB overcurrent pins
	USB0_VBUS, USBA_VBUS	Input	USB cable connection/disconnection detection input pins
CAN module	CRX0, CRX1-DS, CRX2	Input	Input pins
	CTX0 to CTX2	Output	Output pins
Serial peripheral interface	RSPCKA-A/RSPCKA-B	I/O	Clock input/output pin
	MOSIA-A/MOSIA-B	I/O	Inputs or outputs data output from the master
	MISOA-A/MISOA-B	I/O	Inputs or outputs data output from the slave
	SSLA0-A/SSLA0-B	I/O	Input or output pin for slave selection
	SSLA1-A/SSLA1-B to SSLA3-A/SSLA3-B	Output	Output pin for slave selection
Quad serial peripheral interface	QSPCLK-A/-B	Output	QSPI clock output pin
	QSSL-A/-B	Output	QSPI slave output pin
	QMO-A/-B, QIO0-A/-B	I/O	Master transmit data/data 0
	QMI-A/-B, QIO1-A/-B	I/O	Master input data/data 1
	QIO2-A/-B, QIO3-A/-B	I/O	Data 2, data 3
Serial sound interface	SSISCK0, SSISCK1	I/O	SSI serial bit clock pins
	SSIWS0, SSIWS1	I/O	Word select pins
	SSITXD0, SSITXD1	Output	Serial data output pins
	SSIRXD0, SSIRXD1	Input	Serial data input pins
	SSIDATA0, SSIDATA1	I/O	Serial data input/output pins
	AUDIO_MCLK	Input	Master clock pin for audio



Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.6, List of Pin and Pin Functions (176-Pin LFQFP).

Figure 1.5 Pin Assignment (176-Pin LFQFP)

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (1/7)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
1	AVSS0							
2		P05					IRQ13	DA1
3	AVCC1							
4		P03					IRQ11	DA0
5	AVSS1							
6		P02		TMCI1	SCK6		IRQ10	AN120
7		P01		TMCI0	RXD6/SMISO6/ SSCL6		IRQ9	AN119
8		P00		TMRI0	TXD6/SMOSI6/ SSDA6		IRQ8	AN118
9		PF5					IRQ4	
10	EMLE							
11		PJ5		POE8#	CTS2#/RTS2#/SS2#			
12	VSS							
13		PJ3	EDACK1	MTIOC3C	ET0_EXOUT/ CTS6#/RTS6#/ CTS0#/RTS0#/ SS6#/SS0#			
14	VCL							
15	VBATT							
16	NC							
17	TRST#	PF4						
18	MD/FINED							
19	XCIN							
20	XCOUT							
21	RES#							
22	XTAL	P37						
23	VSS							
24	EXTAL	P36						
25	VCC							
26	UPSEL	P35					NMI	
27		P34		MTIOC0A/TMCI3/ PO12/POE10#	SCK6/SCK0/ ET0_LINKSTA		IRQ4	
28		P33	EDREQ1	MTIOC0D/TIOCD0/ TMRI3/PO11/POE4#/ POE11#	RXD6/RXD0/ SMISO6/ SMISO0/SSCL6/ SSCL0/CRX0	PCKO	IRQ3-DS	
29		P32		MTIOC0C/TIOCC0/ TMO3/PO10/ RTCOUT/RTCIC2/ POE0#/POE10#	TXD6/TXD0/ SMOSI6/SMOSI0/ SSDA6/SSDA0/ CTX0/ USB0_VBUSEN	VSYNC	IRQ2-DS	
30	TMS	PF3						
31	TDI	PF2			RXD1/SMISO1/ SSCL1			
32		P31		MTIOC4D/TMCI2/ PO9/RTCIC1	CTS1#/RTS1#/ SS1#/ET1_MDC		IRQ1-DS	
33		P30		MTIOC4B/TMRI3/ PO8/RTCIC0/POE8#	RXD1/SMISO1/ SSCL1/ ET1_MDIO		IRQ0-DS	
34	TCK	PF1			SCK1			
35	TDO	PF0			TXD1/SMOSI1/ SSDA1			

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (3/4)

Pin Number 100-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
57		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/ TMO0/PO27/POE11#	SCK6/ET0_RX_ER/ RMII0_RX_ER			
58		PB2	A10	TIOCC3/TCLKC/ PO26	CTS6#/RTS6#SS6#/ ET0_RX_CLK/ REF50CK0			
59		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/ SSDA6/ET0_ERXD0/ RMII0_RXD0		IRQ4-DS	
60	VCC							
61		PB0	A8	MTIC5W/TIOCA3/ PO24	RXD6/SMISO6/ SSCL6/ET0_ERXD1/ RMII0_RXD1		IRQ12	
62	VSS							
63		PA7	A7	TIOCB2/PO23	MISOA-B/ET0_WOL			
64		PA6	A6	MTIC5V/MTCLKB/ GTETRG-C/TIOCA2/ TMCI3/PO22/POE10#	CTS5#/RTS5#/SS5#/ MOSIA-B/ ET0_EXOUT			
65		PA5	A5	MTIOC6B/TIOCB1/ GTIOC0A-C/PO21	RSPCKA-B/ ET0_LINKSTA			
66		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/ SSDA5/SSLA0-B/ ET0_MDC		IRQ5-DS	
67		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/ SSCL5/ET0_MDIO		IRQ6-DS	
68		PA2	A2	MTIOC7A/ GTIOC1A-C/PO18	RXD5/SMISO5/ SSCL5/SSLA3-B			
69		PA1	A1	MTIOC0B/MTCLKC/ MTIOC7B/ GTIOC2A-C/TIOCB0/ PO17	SCK5/SSLA2-B/ ET0_WOL		IRQ11	
70		PA0	A0/BC0#	MTIOC4A/MTIOC6D/ GTIOC0B-C/TIOCA0/ CACREF/PO16	SSLA1-B/ ET0_TX_EN/ RMII0_TXD_EN			
71		PE7	D15[A15/D15]	MTIOC6A/ GTIOC3A-E/TOC1		MMC_RES#-B/ SDHI_WP-B	IRQ7	AN105
72		PE6	D14[A14/D14]	MTIOC6C/GTIOC3B-E/TIC1		MMC_CD-B/ SDHI_CD-B	IRQ6	AN104
73		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ GTIOC0A-A	ET0_RX_CLK/ REF50CK0		IRQ5	AN103
74		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ GTIOC1A-A/PO28	ET0_ERXD2			AN102
75		PE3	D11[A11/D11]	MTIOC4B/ GTIOC2A-A/PO26/ POE8#/TOC3	CTS12#/RTS12#/ SS12#/ET0_ERXD3	MMC_D7-B		AN101
76		PE2	D10[A10/D10]	MTIOC4A/ GTIOC0B-A/PO23/ TIC3	RXD12/SMISO12/ SSCL12/RXDX12	MMC_D6-B	IRQ7-DS	AN100
77		PE1	D9[A9/D9]	MTIOC4C/MTIOC3B/ GTIOC1B-A/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12	MMC_D5-B		ANEX1
78		PE0	D8[A8/D8]	MTIOC3D/ GTIOC2B-A	SCK12	MMC_D4-B		ANEX0
79		PD7	D7[A7/D7]	MTIC5U/POE0#		MMC_D1-B/ SDHI_D1-B/ QIO1-B/ QMI-B	IRQ7	AN107
80		PD6	D6[A6/D6]	MTIC5V/MTIOC8A/ POE4#		MMC_D0-B/ SDHI_D0-B/ QIO0-B/ QMO-B	IRQ6	AN106

Table 4.1 List of I/O Registers (Address Order) (17 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 830Eh	RIIC0	Slave Address Register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 830Fh	RIIC0	Slave Address Register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8310h	RIIC0	I2C-Bus Bit Rate Low-Level Register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8311h	RIIC0	I2C-Bus Bit Rate High-Level Register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8312h	RIIC0	I2C-Bus Transmit Data Register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8313h	RIIC0	I2C-Bus Receive Data Register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8340h	RIIC2	I2C-Bus Control Register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8341h	RIIC2	I2C-Bus Control Register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8342h	RIIC2	I2C-Bus Mode Register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8343h	RIIC2	I2C-Bus Mode Register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8344h	RIIC2	I2C-Bus Mode Register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8345h	RIIC2	I2C-Bus Function Enable Register	ICFER	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8346h	RIIC2	I2C-Bus Status Enable Register	ICSER	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8347h	RIIC2	I2C-Bus Interrupt Enable Register	ICIER	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8348h	RIIC2	I2C-Bus Status Register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8349h	RIIC2	I2C-Bus Status Register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Ah	RIIC2	Slave Address Register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Bh	RIIC2	Slave Address Register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Ch	RIIC2	Slave Address Register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Dh	RIIC2	Slave Address Register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Eh	RIIC2	Slave Address Register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 834Fh	RIIC2	Slave Address Register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8350h	RIIC2	I2C-Bus Bit Rate Low-Level Register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8351h	RIIC2	I2C-Bus Bit Rate High-Level Register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8352h	RIIC2	I2C-Bus Transmit Data Register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8353h	RIIC2	I2C-Bus Receive Data Register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	RIICa
0008 8500h	MMCIF	Command Setting Register	CECMDSET	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8508h	MMCIF	Argument Register	CEARG	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 850Ch	MMCIF	Automatically Issued CMD12 Argument Register	CEARGCMD12	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8510h	MMCIF	Command Control Register	CECMDCTRL	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8514h	MMCIF	Transfer Block Setting Register	CEBLOCKSET	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8518h	MMCIF	Clock Control Register	CECLKCTRL	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 851Ch	MMCIF	Buffer Access Setting Register	CEBUFACC	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8520h	MMCIF	Response Register 3	CERESP3	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8524h	MMCIF	Response Register 2	CERESP2	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8528h	MMCIF	Response Register 1	CERESP1	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 852Ch	MMCIF	Response Register 0	CERESP0	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8530h	MMCIF	Automatically Issued CMD12 Response Register	CERESPCMD12	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8534h	MMCIF	Data Register	CEDATA	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 853Ch	MMCIF	Boot Operation Setting Register	CEBOOT	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8540h	MMCIF	Interrupt status Flag Register	CEINT	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8544h	MMCIF	Interrupt request Enable Register	CEINTEN	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8548h	MMCIF	Status Register 1	CEHOSTSTS1	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 854Ch	MMCIF	Status Register 2	CEHOSTSTS2	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8570h	MMCIF	MMC Detection and Port Control Register	CEDETECT	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 8574h	MMCIF	Special Mode Setting Register	CEADDMODE	32	32	2, 3 PCLKB	2 ICLK	MMCIF

Table 4.1 List of I/O Registers (Address Order) (40 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0009 0420h	CAN0	FIFO Received ID Compare Register 0	FIDCR0	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 0424h	CAN0	FIFO Received ID Compare Register 1	FIDCR1	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 0428h	CAN0	Mask Invalid Register	MKIVLR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 042Ch	CAN0	Mailbox Interrupt Enable Register	MIER	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 0820h to 0009 083Fh	CAN0	Message Control Registers 0 to 31	MCTL0 to 31	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0840h	CAN0	Control Register	CTLR	16	8, 16	2, 3 PCLKB	2 ICLK	CAN
0009 0842h	CAN0	Status Register	STR	16	8, 16	2, 3 PCLKB	2 ICLK	CAN
0009 0844h	CAN0	Bit Configuration Register	BCR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 0848h	CAN0	Receive FIFO Control Register	RFCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0849h	CAN0	Receive FIFO Pointer Control Register	RFPCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Ah	CAN0	Transmit FIFO Control Register	TFCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Bh	CAN0	Transmit FIFO Pointer Control Register	TFPCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Ch	CAN0	Error Interrupt Enable Register	EIER	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Dh	CAN0	Error Interrupt Factor Judge Register	EIFR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Eh	CAN0	Receive Error Count Register	RECR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 084Fh	CAN0	Transmit Error Count Register	TECR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0850h	CAN0	Error Code Store Register	ECSR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0851h	CAN0	Channel Search Support Register	CSSR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0852h	CAN0	Mailbox Search Status Register	MSSR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0853h	CAN0	Mailbox Search Mode Register	MSMR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 0854h	CAN0	Time Stamp Register	TSR	16	16	2, 3 PCLKB	2 ICLK	CAN
0009 0856h	CAN0	Acceptance Filter Support Register	AFSR	16	8, 16	2, 3 PCLKB	2 ICLK	CAN
0009 0858h	CAN0	Test Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 1200h to 0009 13FFh	CAN1	Mailbox Registers 0 to 31	MB0 to 31	128	8, 16, 32*6	2, 3 PCLKB	2 ICLK	CAN
0009 1400h to 0009 141Fh	CAN1	Mask Registers 0 to 7	MKR0 to 7	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 1420h	CAN1	FIFO Received ID Compare Register 0	FIDCR0	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 1424h	CAN1	FIFO Received ID Compare Register 1	FIDCR1	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 1428h	CAN1	Mask Invalid Register	MKIVLR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 142Ch	CAN1	Mailbox Interrupt Enable Register	MIER	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 1820h to 0009 183Fh	CAN1	Message Control Registers 0 to 31	MCTL0 to 31	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 1840h	CAN1	Control Register	CTLR	16	8, 16	2, 3 PCLKB	2 ICLK	CAN
0009 1842h	CAN1	Status Register	STR	16	8, 16	2, 3 PCLKB	2 ICLK	CAN
0009 1844h	CAN1	Bit Configuration Register	BCR	32	8, 16, 32	2, 3 PCLKB	2 ICLK	CAN
0009 1848h	CAN1	Receive FIFO Control Register	RFCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 1849h	CAN1	Receive FIFO Pointer Control Register	RFPCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Ah	CAN1	Transmit FIFO Control Register	TFCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Bh	CAN1	Transmit FIFO Pointer Control Register	TFPCR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Ch	CAN1	Error Interrupt Enable Register	EIER	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Dh	CAN1	Error Interrupt Factor Judge Register	EIFR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Eh	CAN1	Receive Error Count Register	RECR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 184Fh	CAN1	Transmit Error Count Register	TECR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 1850h	CAN1	Error Code Store Register	ECSR	8	8	2, 3 PCLKB	2 ICLK	CAN
0009 1851h	CAN1	Channel Search Support Register	CSSR	8	8	2, 3 PCLKB	2 ICLK	CAN

Table 4.1 List of I/O Registers (Address Order) (42 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0009 42A0h	CMTW1	Output Compare Register 0	CMWOCR0	32	32	2, 3 PCLKB	2 ICLK	CMTW
0009 42A4h	CMTW1	Output Compare Register 1	CMWOCR1	32	32	2, 3 PCLKB	2 ICLK	CMTW
0009 8000h to 0009 D6BFh	SRC	Filter Coefficient Table	SRCFCTR0 to 5551	32	32	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFF0h	SRC	Input Data Register	SRCID	32	32	5, 6 PCLKB	2, 3 ICLK	SRC
0009 DFF4h	SRC	Output Data Register	SRCOD	32	32	5, 6 PCLKB	2, 3 ICLK	SRC
0009 DFF8h	SRC	Input Data Control Register	SRCIDCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFAh	SRC	Output Data Control Register	SRCODCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFCh	SRC	Control Register	SRCCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFEh	SRC	Status Register	SRCSTAT	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
000A 0000h	USB0	System Configuration Control Register	SYSCFG	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0004h	USB0	System Configuration Status Register 0	SYSSTS0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0008h	USB0	Device State Control Register 0	DVSTCTR0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0014h	USB0	CFIFO Port Register	CFIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 0018h	USB0	D0FIFO Port Register	D0FIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 001Ch	USB0	D1FIFO Port Register	D1FIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 0020h	USB0	CFIFO Port Select Register	CFIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0022h	USB0	CFIFO Port Control Register	CFIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0028h	USB0	D0FIFO Port Select Register	D0FIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Ah	USB0	D0FIFO Port Control Register	D0FIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Ch	USB0	D1FIFO Port Select Register	D1FIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Eh	USB0	D1FIFO Port Control Register	D1FIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0030h	USB0	Interrupt Enable Register 0	INTENB0	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0032h	USB0	Interrupt Enable Register 1	INTENB1	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0036h	USB0	BRDY Interrupt Enable Register	BRDYENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0038h	USB0	NRDY Interrupt Enable Register	NRDYENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 003Ah	USB0	BEMP Interrupt Enable Register	BEMPENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 003Ch	USB0	SOF Output Configuration Register	SOFCFG	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0040h	USB0	Interrupt Status Register 0	INTSTS0	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0042h	USB0	Interrupt Status Register 1	INTSTS1	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0046h	USB0	BRDY Interrupt Status Register	BRDYSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0048h	USB0	NRDY Interrupt Status Register	NRDYSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Ah	USB0	BEMP Interrupt Status Register	BEMPSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Ch	USB0	Frame Number Register	FRMNUM	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Eh	USB0	Device State Change Register	DVCHGR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb

Table 5.14 LOCO and IWDT-Dedicated Low-Speed Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
LOCO clock cycle time	t_{Lcyc}	4.63	4.16	3.78	µs	
LOCO clock oscillation frequency	f_{LOCO}	216	240	264	kHz	
LOCO clock oscillation stabilization wait time	t_{LOCOWT}	—	—	44	µs	Figure 5.6
IWDT-dedicated low-speed clock cycle time	t_{ILcyc}	9.26	8.33	7.57	µs	
IWDT-dedicated low-speed clock oscillation frequency	f_{ILOCO}	108	120	132	kHz	
IWDT-dedicated low-speed clock oscillation stabilization wait time	$t_{ILOCOWT}$	—	142	190	µs	Figure 5.7

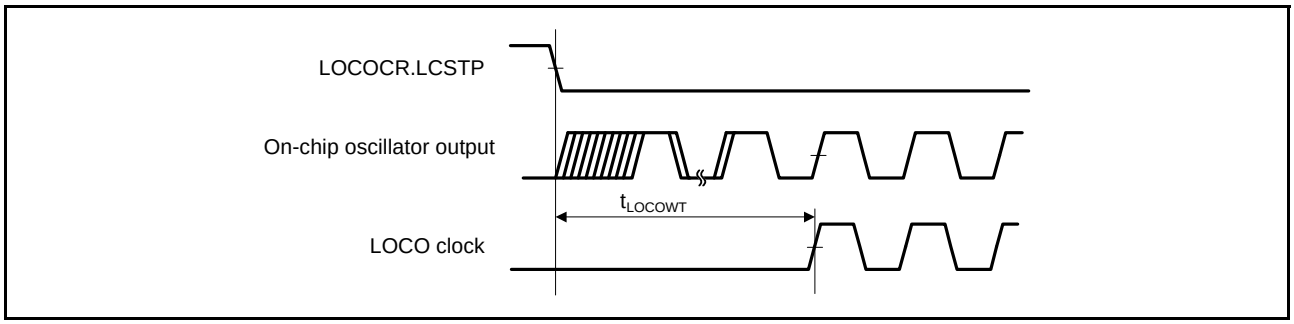


Figure 5.6 LOCO Clock Oscillation Start Timing

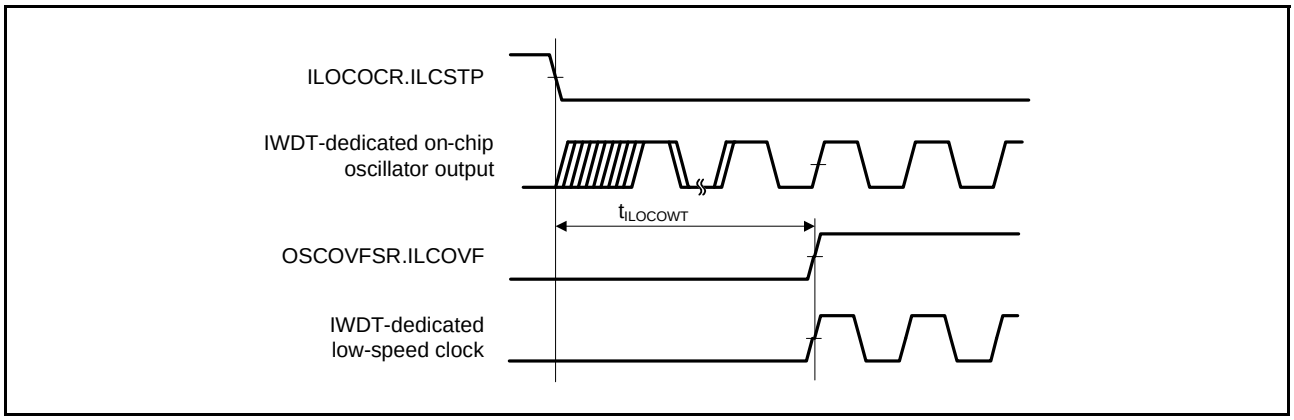


Figure 5.7 IWDT-dedicated Low-Speed Clock Oscillation Start Timing

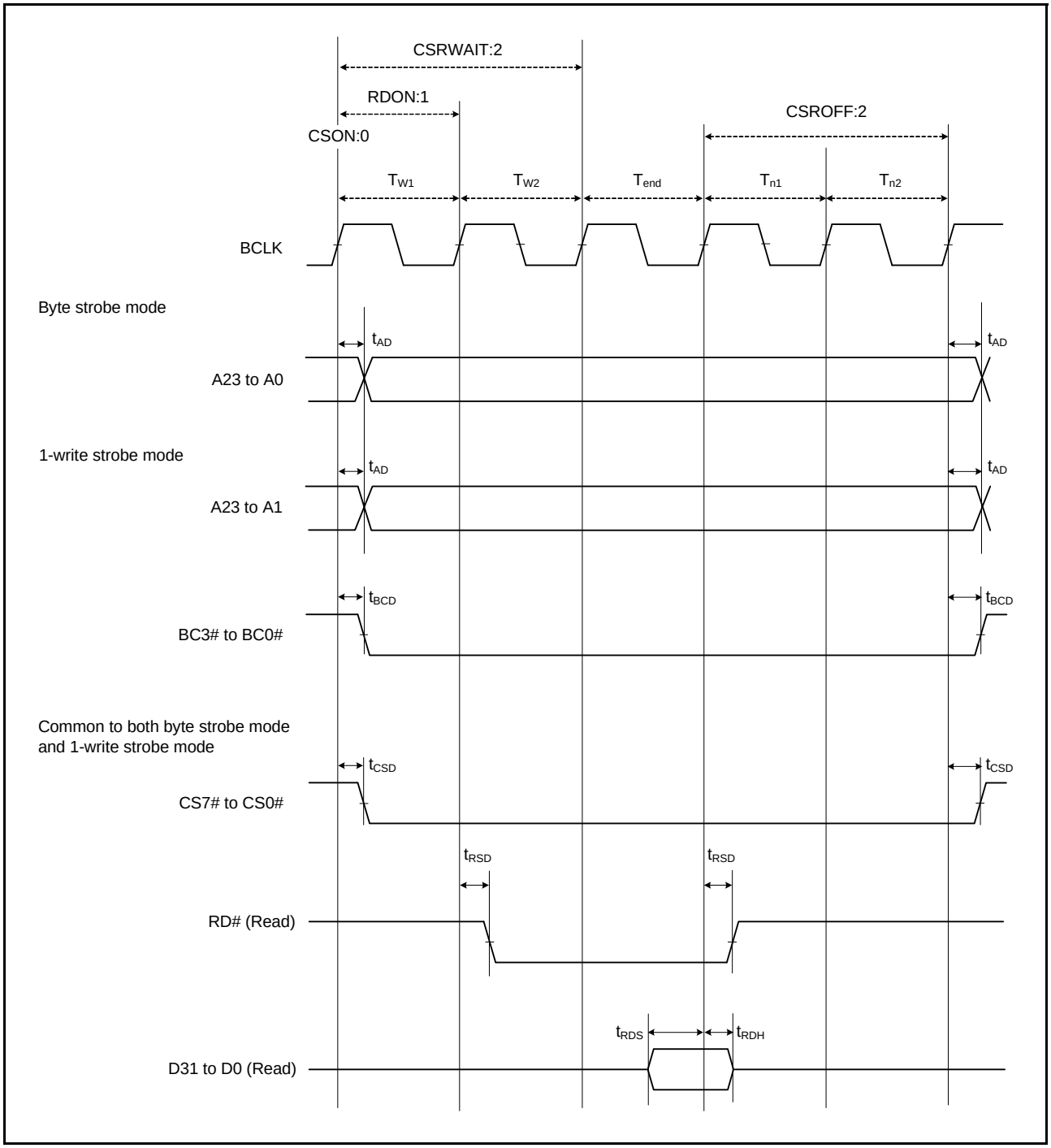
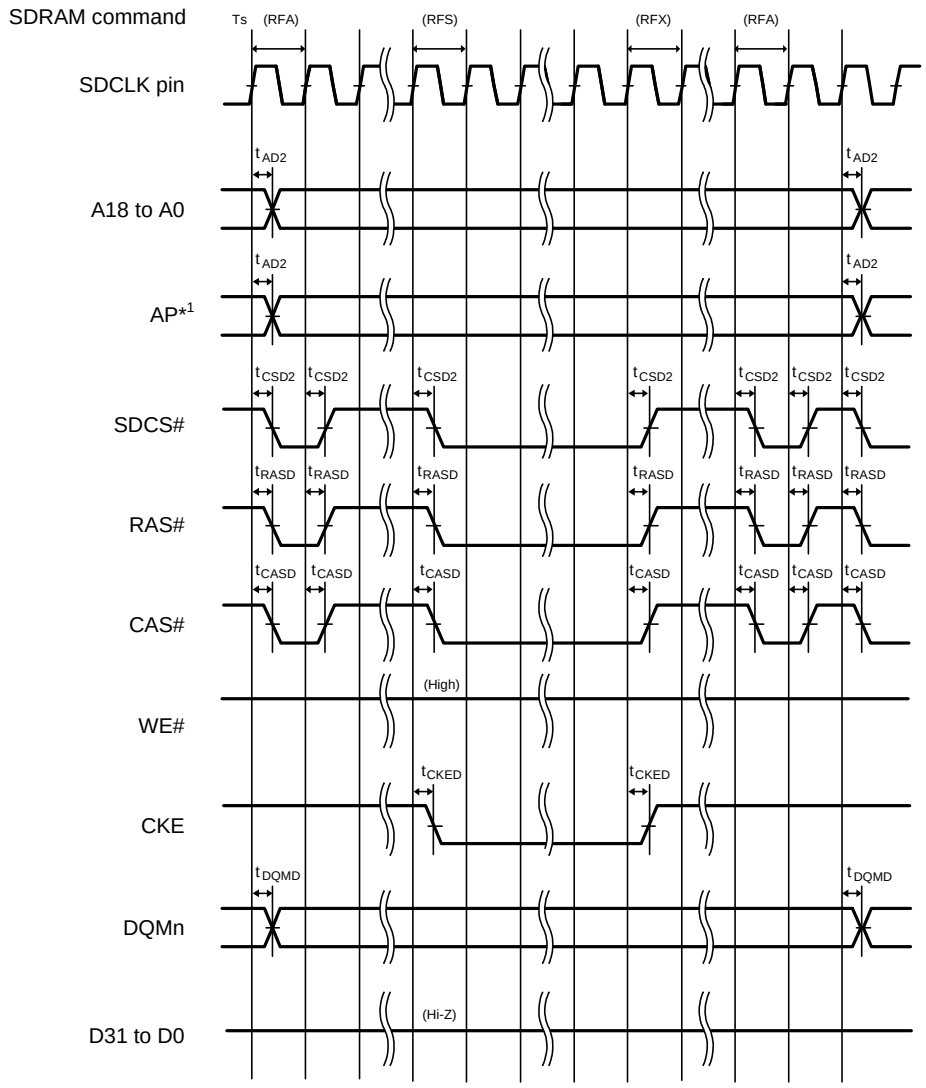


Figure 5.18 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)



Note 1. Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.29 SDRAM Space Self-Refresh Bus Timing

Table 5.33 RSPI Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item				Symbol	Min.*1	Max.*1	Unit*1	Test Conditions*2
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{PAcyc}	Figure 5.46
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock rise/fall time	Output		t_{SPCKr}, t_{SPCKf}	—	5	ns	
		Input			—	1	µs	
	Data input setup time	Master		t_{SU}	6	—	ns	Figure 5.47 to Figure 5.52
		Slave			$8.3 - t_{PAcyc}$	—		
	Data input hold time	Master	PCLKA division ratio set to 1/2	t_{HF}	0	—	ns	
			PCLKA division ratio set to a value other than 1/2	t_H	t_{PAcyc}	—		
		Slave			$8.3 + 2 \times t_{PAcyc}$	—		
	SSL setup time	Master		t_{LEAD}	1	8	t_{SPcyc}	
		Slave			4	—	t_{PAcyc}	
	SSL hold time	Master		t_{LAG}	1	8	t_{SPcyc}	
		Slave			4	—	t_{PAcyc}	
	Data output delay time	Master		t_{OD}	—	6.3	ns	
		Slave			—	$3 \times t_{PAcyc} + 20$		
	Data output hold time	Master		t_{OH}	0	—	ns	
		Slave			0	—		
	Successive transmission delay time	Master		t_{TD}	$t_{SPcyc} + 2 \times t_{PAcyc}$	$8 \times t_{SPcyc} + 2 \times t_{PAcyc}$	ns	
		Slave			$4 \times t_{PAcyc}$	—		
	MOSI and MISO rise/fall time	Output		t_{Dr}, t_{Df}	—	5	ns	
		Input			—	1	µs	
	SSL rise/fall time	Output		t_{SSLr}, t_{SSLf}	—	5	ns	
		Input			—	1	µs	
	Slave access time			t_{SA}	—	4	t_{PAcyc}	Figure 5.51, Figure 5.52
	Slave output release time			t_{REL}	—	3	t_{PAcyc}	

Note 1. t_{PAcyc}: PCLKA cycle
Note 2. We recommend using pins that have a letter (“-A”, “-B”, etc.) to indicate group membership appended to their names as groups. For the RSPI interface, the AC portion of the electrical characteristics is measured for each group.

Table 5.37 RIIC Timing (2)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.*1, *2	Max.	Unit	Test Conditions
RIIC (Fast-mode+) ICFER.FMPE = 1	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 240	—	ns	Figure 5.56
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 120	—	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 120	—	ns	
	SCL, SDA input rise time	t_{Sr}	—	120	ns	
	SCL, SDA input fall time	t_{Sf}	—	120	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 120	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 120	—	ns	
	Restart condition input setup time	t_{STAS}	120	—	ns	
	Stop condition input setup time	t_{STOS}	120	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 20	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	550	pF	
Simple IIC (Standard-mode)	SDA input rise time	t_{Sr}	—	1000	ns	
	SDA input fall time	t_{Sf}	—	300	ns	
	SDA input spike pulse removal time	t_{SP}	0	4 × t_{PBcyc}	ns	
	Data input setup time	t_{SDAS}	250	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
Simple IIC (Fast-mode)	SCL, SDA input rise time	t_{Sr}	—	300	ns	
	SCL, SDA input fall time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	4 × t_{PBcyc}	ns	
	Data input setup time	t_{SDAS}	100	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: t_{IICcyc}: RIIC internal reference clock (IICϕ) cycle, t_{PBcyc}: PCLKB cycle
Note 1. The value within parentheses is applicable when the value of the ICMR3.NF[1:0] bits is 11b while the digital filter is enabled by the setting ICFER.NFE = 1.
Note 2. Cb is the total capacitance of the bus lines.

Table 5.38 Serial Sound Interface Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
SSI	AUDIO_CLK input frequency	t_{AUDIO}	—	50	MHz	
	Output clock cycle	t_O	150	64000	ns	Figure 5.57
	Input clock cycle	t_I	150	64000	ns	
	Clock high level	t_{HC}	60	—	ns	
	Clock low level	t_{LC}	60	—	ns	
	Clock rising time	t_{RC}	—	25	ns	
	Data delay time	t_{DTR}	–5	25	ns	Figure 5.58, Figure 5.59
	Setup time	t_{SR}	25	—	ns	
	Hold time	t_{HTR}	25	—	ns	
	WS change edge SSIDATA output delay	t_{DTRW}	—	25	ns	Figure 5.60

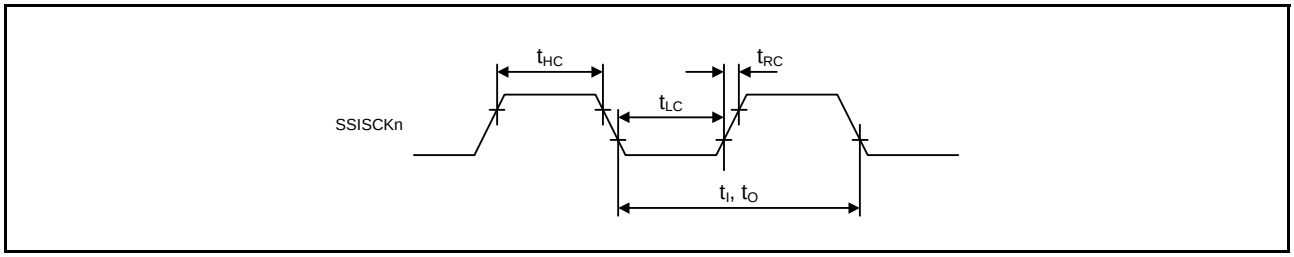


Figure 5.57 Clock Input/Output Timing

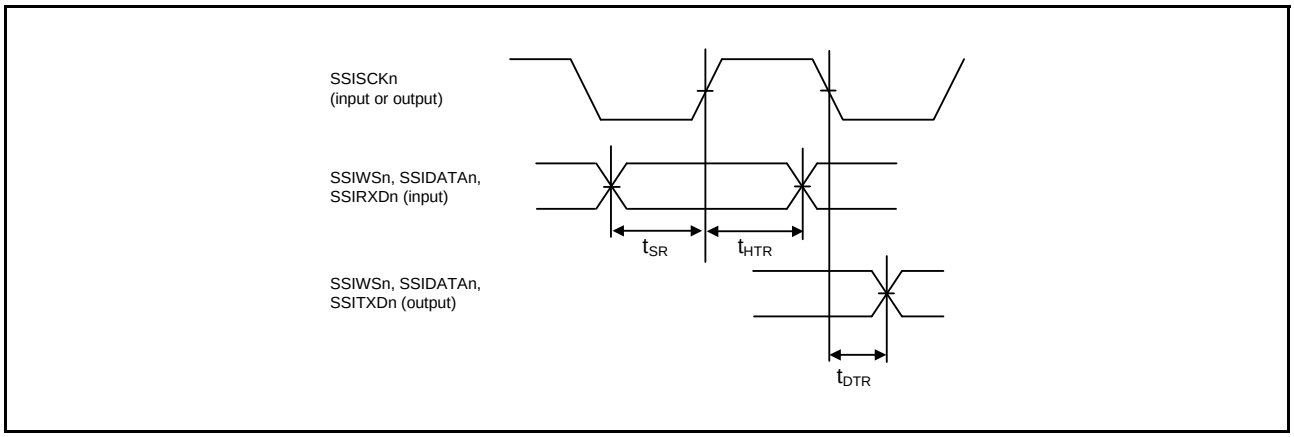


Figure 5.58 Transmit/Receive Timing (SSISCKn Rising Synchronous)

Table 5.39 MMC Host Interface Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.*1	Max.	Unit	Test Conditions*2
MMCIF	MMC_CLK clock cycle	t_{MMCPP}	2 × t_{PBcyc}	—	ns	Figure 5.61
	MMC_CLK clock high level width	t_{MMCWH}	6.5	—	ns	
	MMC_CLK clock low level width	t_{MMCWL}	6.5	—	ns	
	MMC_CLK clock rising time	t_{MMCLH}	—	5	ns	
	MMC_CLK clock falling time	t_{MMCHL}	—	5	ns	
	MMC_CMD, MMC_D7 to MMC_D0 output data delay (data transfer mode)	$t_{MMCODLY}$	–6.5	6.5	ns	
	MMC_CMD, MMC_D7 to MMC_D0 input data setup	t_{MMCISU}	8	—	ns	
	MMC_CMD, MMC_D7 to MMC_D0 input data hold	t_{MMCIH}	2	—	ns	

Note 1. t_{PBcyc}: PCLKB cycle
Note 2. We recommend using pins that have a letter (“-A”, “-B”, etc.) to indicate group membership appended to their names as groups. For the MMC interface, the AC portion of the electrical characteristics is measured for each group.

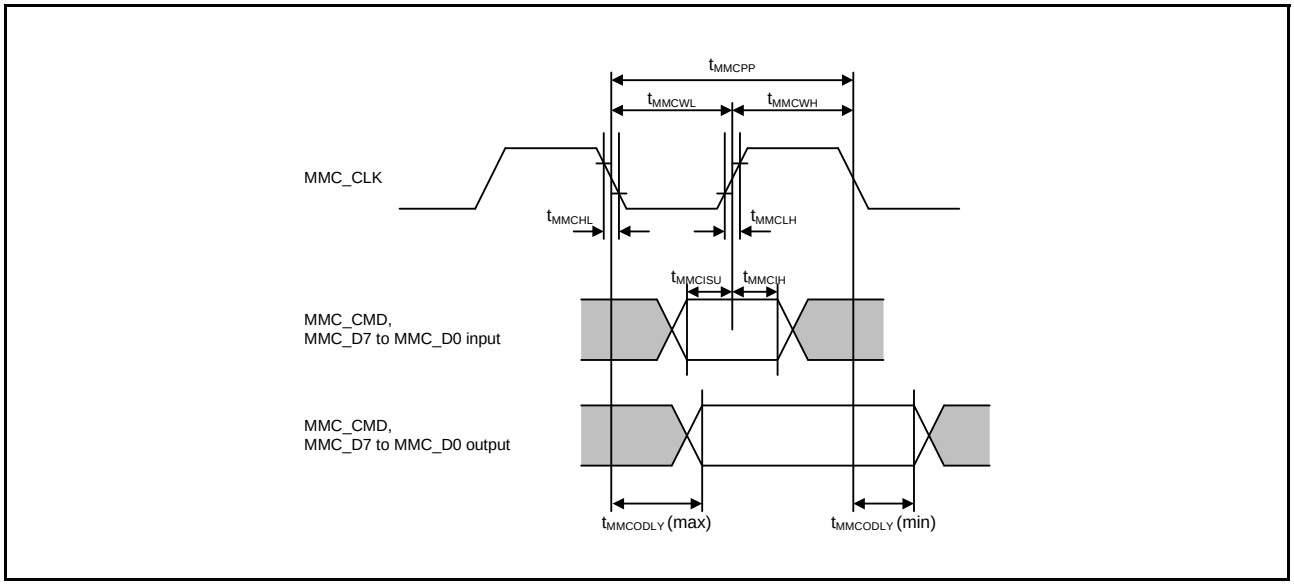


Figure 5.61 MMC Interface

5.4 USB Characteristics

Table 5.42 On-Chip USB Low Speed (Host Only) Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, UCLK = 48 MHz,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V_{IH}	2.0	—	—	V	
	Input low level voltage	V_{IL}	—	—	0.8	V	
	Differential input sensitivity	V_{DI}	0.2	—	—	V	| DP – DM |
	Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V_{OH}	2.8	—	3.6	V	I_{OH} = –200 µA
	Output low level voltage	V_{OL}	0.0	—	0.3	V	I_{OL} = 2 mA
	Cross-over voltage	V_{CRS}	1.3	—	2.0	V	Figure 5.75
	Rise time	t_{LR}	75	—	300	ns	
	Fall time	t_{LF}	75	—	300	ns	
	Rise/fall time ratio	t_{LR} / t_{LF}	80	—	125	%	t_{LR}/ t_{LF}
Pull-down characteristics	DP/DM pull-down resistance (when the host controller function is selected)	R_{pd}	14.25	—	24.80	kΩ	

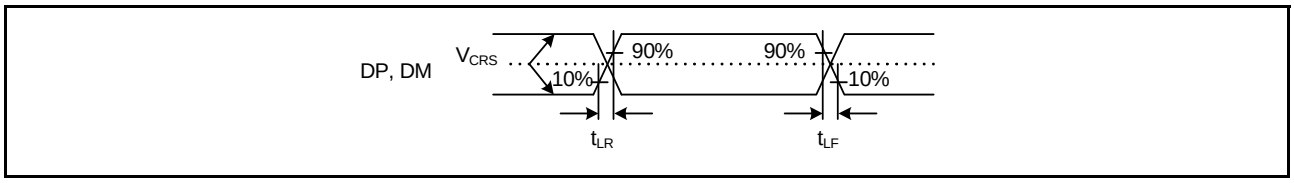


Figure 5.75 DP and DM Output Timing (Low Speed)

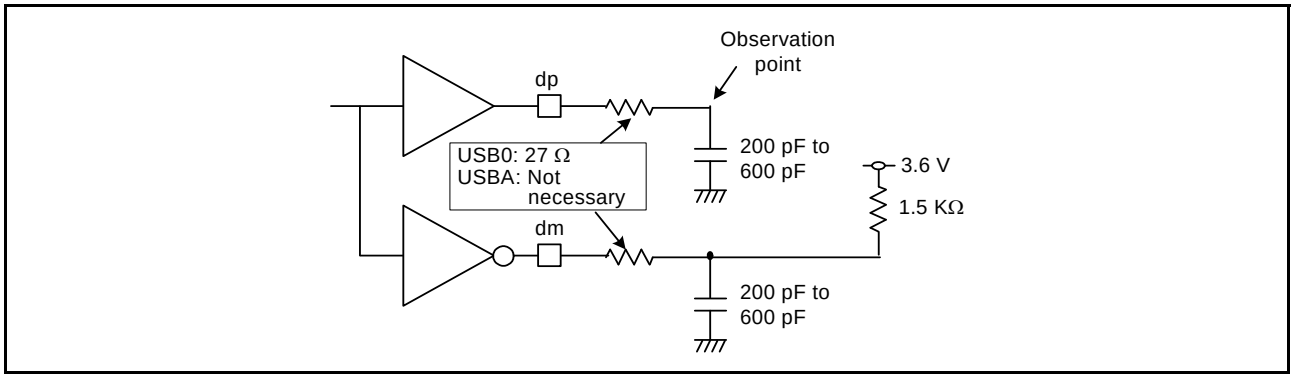


Figure 5.76 Test Circuit (Low Speed)

5.5 A/D Conversion Characteristics

Table 5.45 12-Bit A/D (Unit 0) Conversion Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKB = PCLKC = 1 MHz to 60 MHz, $T_a = T_{opr}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		8	—	12	Bit	
Analog input capacitance		—	—	30	pF	
Channel-dedicated sample-and-hold circuits in use (AN000 to AN002)	Conversion time*1 (Operation at PCLK = 60 MHz) Permissible signal source impedance (max.) = 1.0 kΩ	1.06 (0.40 + 0.25) *2	—	—	μs	• Sampling of channel-dedicated sample-and-hold circuits in 24 states • Sampling in 15 states
	Offset error	—	±1.5	±3.5	LSB	AN000 to AN002 = 0.25 V
	Full-scale error	—	±1.5	±3.5	LSB	AN000 to AN002 = VREFH0 - 0.25 V
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	±2.5	±5.5	LSB	
	DNL differential nonlinearity error	—	±1.0	±2.0	LSB	
	INL integral nonlinearity error	—	±1.5	±3.0	LSB	
	Holding characteristics of sample-and-hold circuits	—	—	20	μs	
	Dynamic range	0.25	—	VREFH0 – 0.25	V	
Channel-dedicated sample-and-hold circuits not in use (AN000 to AN007)	Conversion time*1 (Operation at PCLK = 60 MHz) Permissible signal source impedance (max.) = 1.0 kΩ	0.48 (0.267) *2	—	—	μs	Sampling in 16 states
	Offset error	—	±1.0	±2.5	LSB	
	Full-scale error	—	±1.0	±2.5	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	±2.0	±4.5	LSB	
	DNL differential nonlinearity error	—	±0.5	±1.5	LSB	
	INL integral nonlinearity error	—	±1.0	±2.5	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.
Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.
Note 2. The value in parentheses indicates the sampling time.

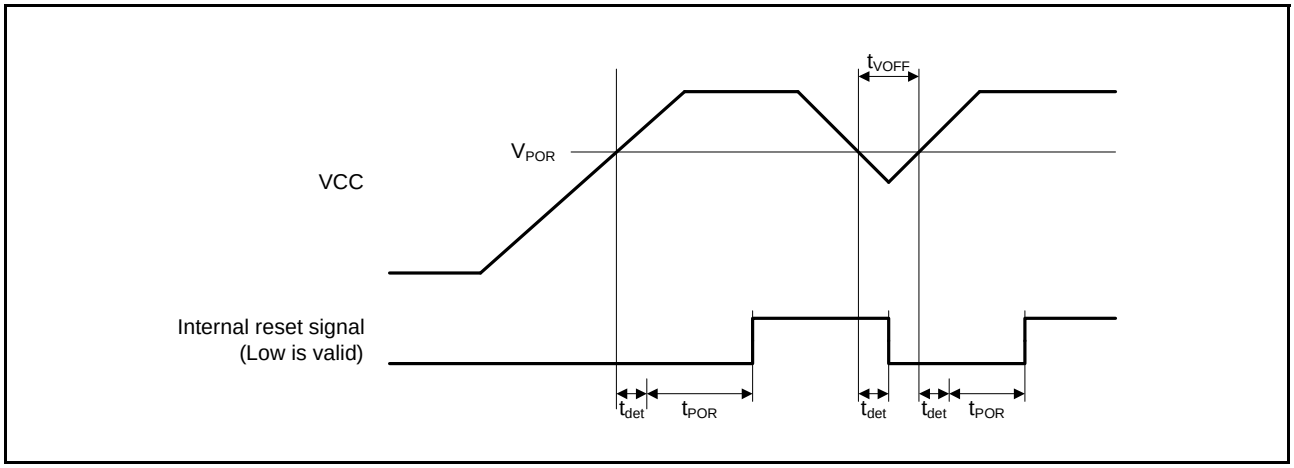


Figure 5.79 Power-on Reset Timing

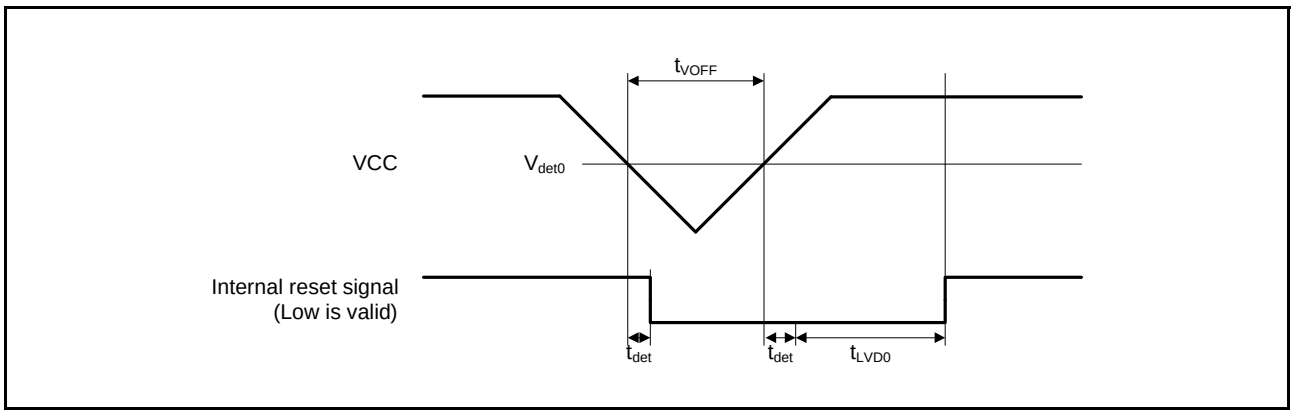


Figure 5.80 Voltage Detection Circuit Timing (V_{det0})

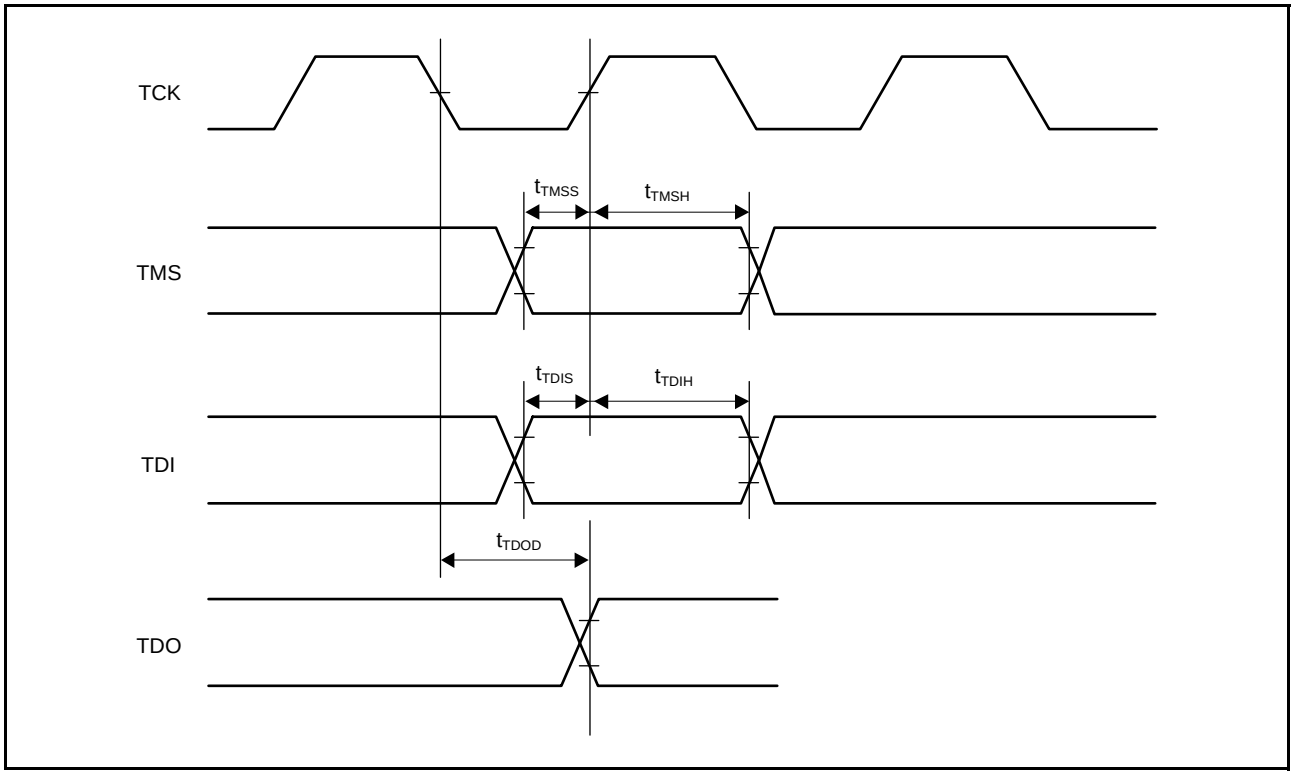
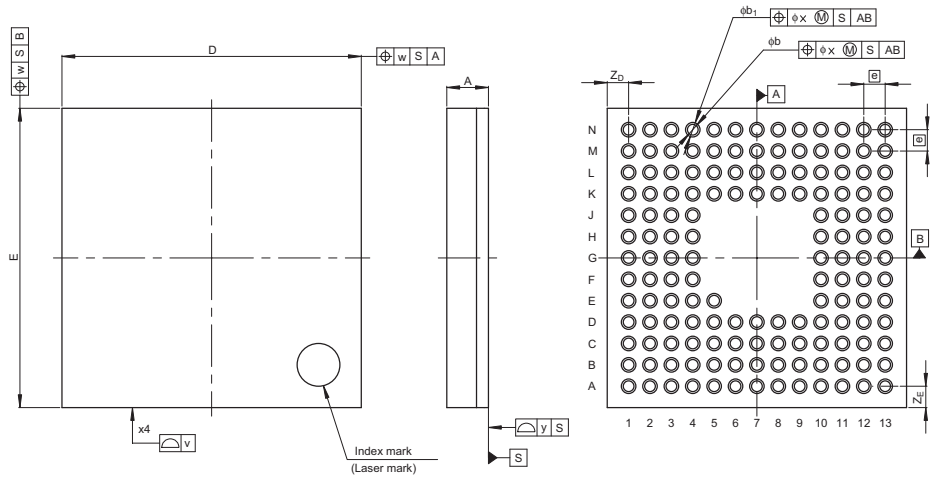


Figure 5.88 Boundary Scan Input/Output Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA145-7x7-0.50	PTLG0145KA-A	145F0G	0.1g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	7.0	—
E	—	7.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.5	—
b	0.21	0.25	0.29
b_1	0.29	0.34	0.39
x	—	—	0.08
y	—	—	0.08
Z_D	—	0.5	—
Z_E	—	0.5	—

Figure D 145-Pin TFLGA (PTLG0145KA-A)